## **Preliminary**



RFM products are now Murata products.

**SF2230A** 

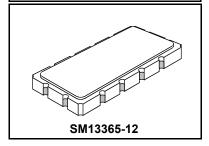
- · Precision IF SAW Filter
- Hermetic 13.3 x 6.5 mm Surface-mount Case
- Complies with Directive 2002/95/EC (RoHS)



#### **Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+20	dBm
Maximum DC Voltage on any Non-ground Terminal	10	VDC
Storage Temperature Range in Tape and Reel -40 to +85 °C		
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	





#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f <sub>C</sub>	1		70.0		
1 dB Bandwidth	BW <sub>1</sub>	1	20.8	21.3		MHz
25 dB Bandwidth	BW <sub>25</sub>	1		27.7	28.5	IVITZ
40 dB Bandwidth	BW <sub>40</sub>	1		29.7		
Insertion Loss	IL	1		13.9	15	dB
Amplitude Ripple, f <sub>C</sub> ± 9.75 MHz		100		0.35	0.60	dB <sub>P-P</sub>
Group Delay Ripple, f <sub>C</sub> ± 9.75 MHz		1, 2, 3		28	45	ns <sub>P-P</sub>
Sidelobe Attenuation:						
Lower Sidelobe			40	45		dB
Upper Sidelobe			38	42		
Operating Temperature Range		1	-45		+85	°C
Frequency Temperature Coefficient				-86		ppm/°C

Impedance Matching to 50 Ω Unbalanced Source/Load	External L-C			
Case Style	SM13365-12 13.3 x 6.5 mm Nominal Footprint			
Lid Symbolization (YY = year, WW = week)	RFM SF2230A YYWW			

#### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.

2. 3.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

Part to part absolute delay measurement records the absolute delay mean across 1 dB passband.

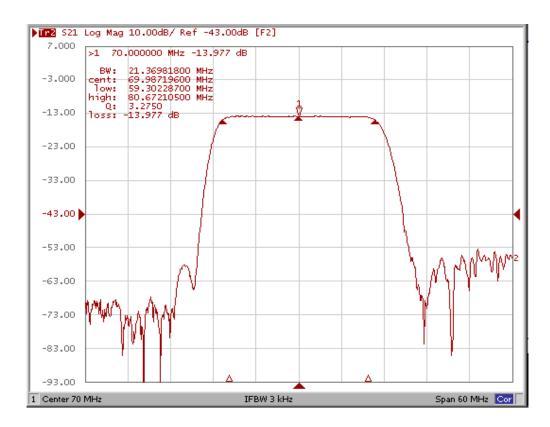
"LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

The design, manufacturing process, and specifications of this filter are subject to change.

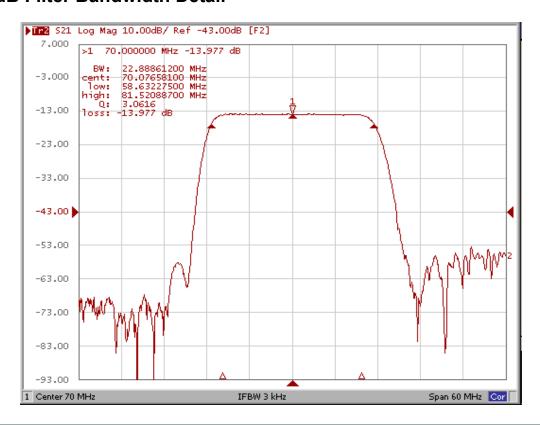
Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.

US and international patents may apply.

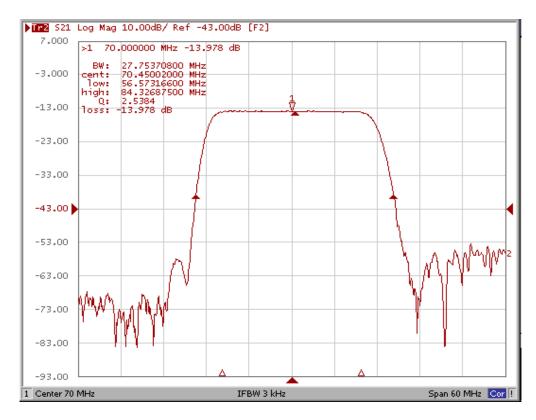
#### 1 dB Filter Bandwidth Detail



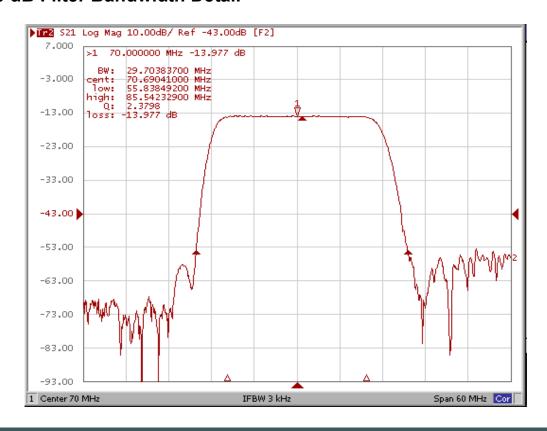
#### 3 dB Filter Bandwidth Detail



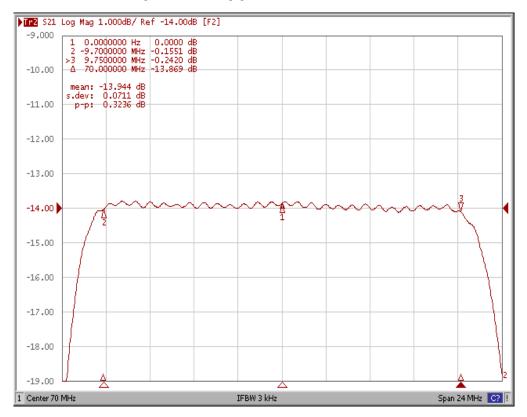
#### 25 dB Filter Bandwidth Detail



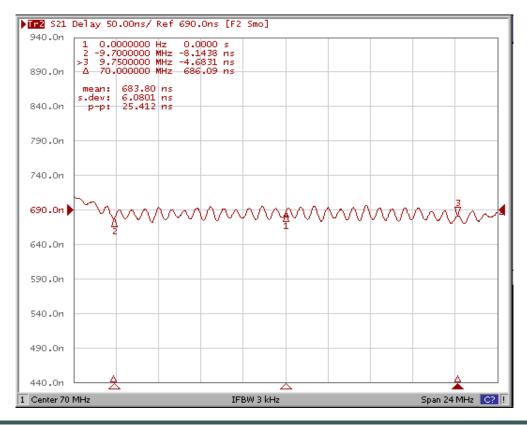
#### 40 dB Filter Bandwidth Detail



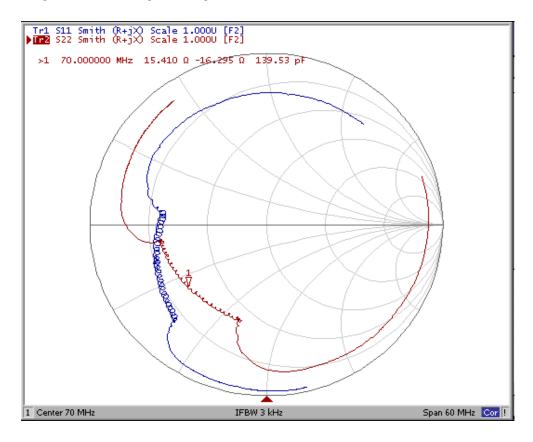
#### **Filter Passband Amplitude Ripple**



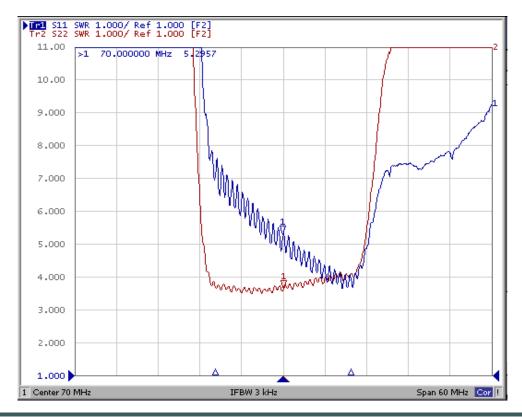
### Filter Passband Group Delay Ripple



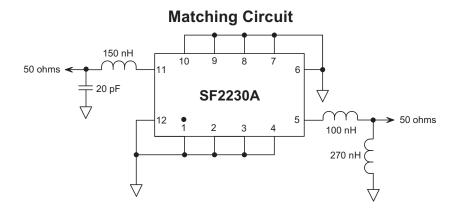
### **Filter Input and Output Impedance Plots**



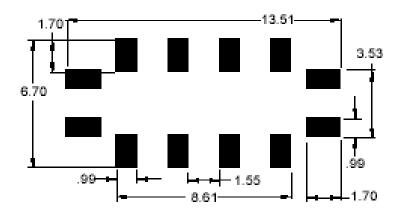
#### **Filter VSWR Plots**



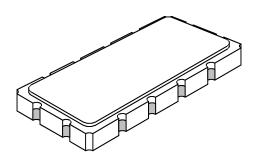
#### **Tuning Component Values**



#### **PCB Pad Layout**



### SM13365-12 Ceramic Surface-mount 12-Terminal Case 13.3 x 6.5 mm Nominal Footprint



#### **Electrical Connections**

Connection	Terminals			
Input	11			
Output	5			
Case Ground	All others			

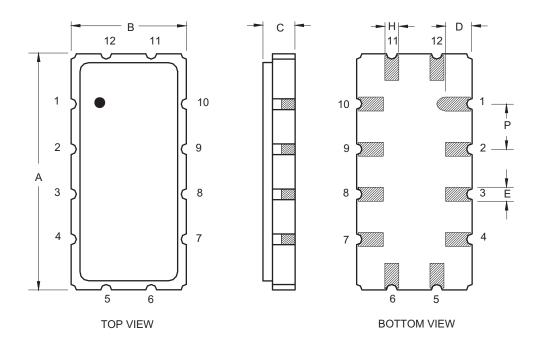
#### **Case Dimensions**

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	13.10	13.30	13.50	0.516	0.524	0.531
В	6.30	6.50	6.70	0.248	0.256	0.264
С			1.80			0.071
D		1.50			0.059	
E		0.80			0.031	
Н		0.80			0.031	
Р		2.54			0.100	

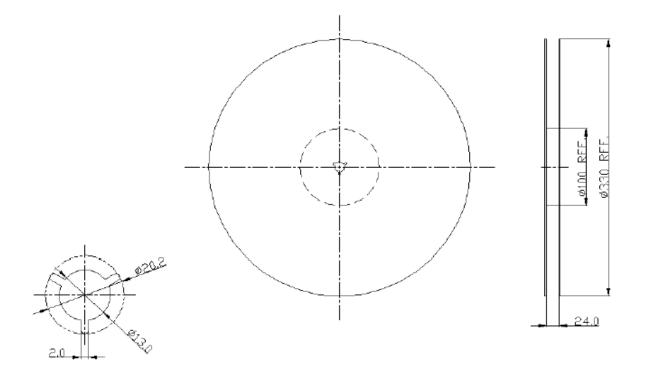
#### **Case Material**

Materials			
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
Pb Free			

#### **Case Outline Drawing**



### **Tape and Reel Details**



# 13.3X6.5

